

2SD2416

Silicon NPN epitaxial planer type darlington

For low-frequency amplification

Features

- High forward current transfer ratio h_{FE} .
- 60V zener diode built in between collector and base.
- Darlington connection.
- Mini Power type package, allowing downsizing of the equipment and automatic insertion through the tape packing and the magazine packing.

Absolute Maximum Ratings (Ta=25°C)

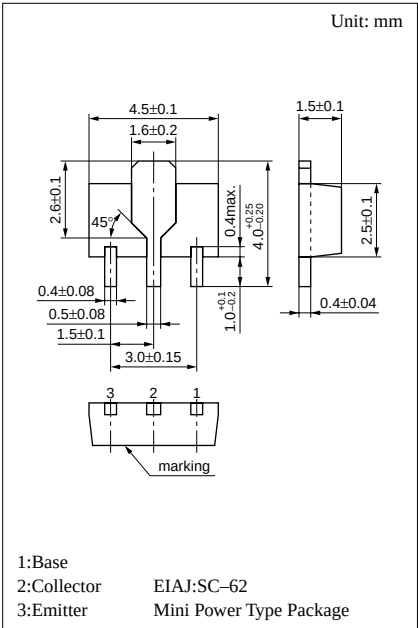
Parameter	Symbol	Ratings	Unit
Collector to base voltage	V_{CBO}	60^{+25}_{-10}	V
Collector to emitter voltage	V_{CEO}	60^{+25}_{-10}	V
Emitter to base voltage	V_{EBO}	5	V
Peak collector current	I_{CP}	1.5	A
Collector current	I_C	1	A
Collector power dissipation	P_C^*	1	W
Junction temperature	T_j	150	°C
Storage temperature	T_{stg}	-55 ~ +150	°C

* Printed circuit board: Copper foil area of 1cm² or more, and the board thickness of 1.7mm for the collector portion

Electrical Characteristics (Ta=25°C)

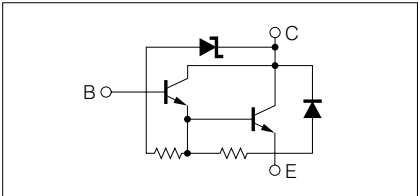
Parameter	Symbol	Conditions	min	typ	max	Unit
Collector cutoff current	I_{CBO}	$V_{CB} = 25V, I_E = 0$			1	μA
Emitter cutoff current	I_{EBO}	$V_{EB} = 4V, I_C = 0$			2	mA
Collector to base voltage	V_{CBO}	$I_C = 100\mu A, I_E = 0$	50		85	V
Collector to emitter voltage	V_{CEO}	$I_C = 1mA, I_B = 0$	50		85	V
Forward current transfer ratio	h_{FE}	$V_{CE} = 10V, I_C = 1.0A^*$	6500		40000	
Collector to emitter saturation voltage	$V_{CE(sat)}$	$I_C = 1.0A, I_B = 1.0mA^*$			1.8	V
Base to emitter saturation voltage	$V_{BE(sat)}$	$I_C = 1.0A, I_B = 1.0mA^*$			2.2	V
Transition frequency	f_T	$V_{CB} = 10V, I_E = -50mA, f = 200MHz$		150		MHz

*2 Pulse measurement

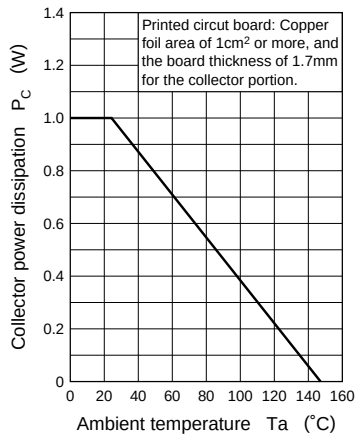


Marking symbol : 1T

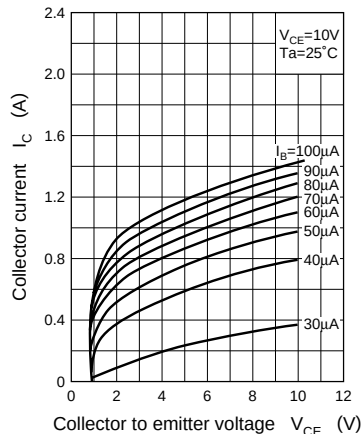
Internal Connection



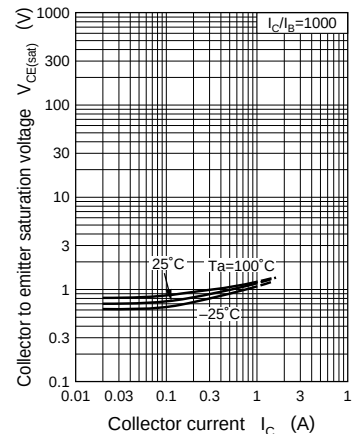
$P_C - T_a$



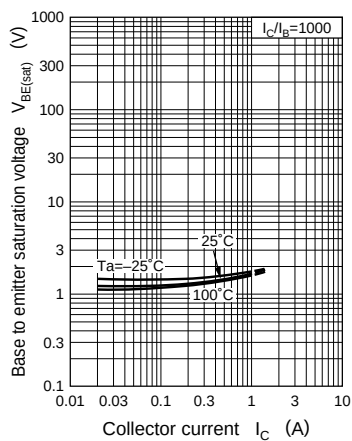
$I_C - V_{CE}$



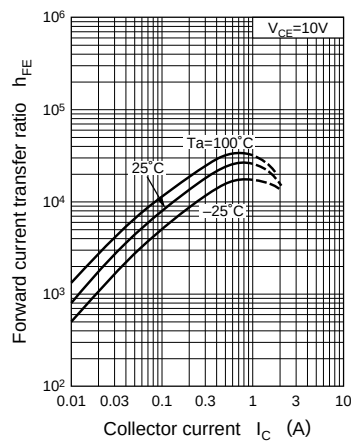
$V_{CE(sat)} - I_C$



$V_{BE(sat)} - I_C$



$h_{FE} - I_C$



$C_{ob} - V_{CB}$

